

STARPOWER

SEMICONDUCTOR

IGBT

GD35PIY120C5SNF

1200V/35A PIM in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

Features

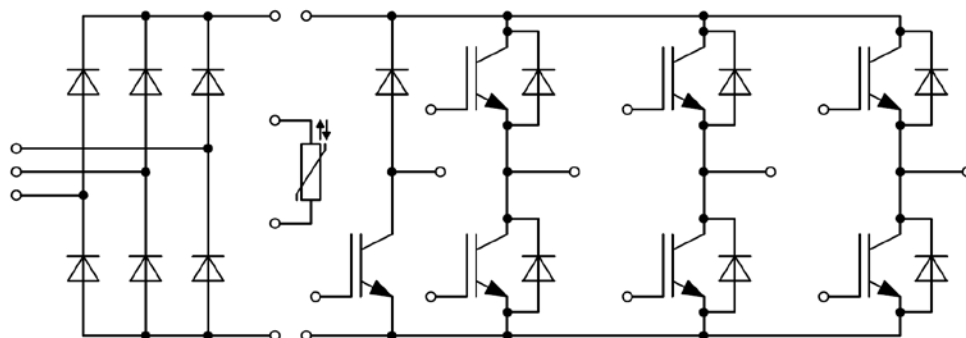
- Low $V_{CE(sat)}$ Trench IGBT technology
- 10 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology
- PressFIT contact technology



Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_C=25^{\circ}\text{C}$ unless otherwise noted**IGBT-inverter**

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$	69	A
	@ $T_C=100^{\circ}\text{C}$	35	
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	70	A
P_D	Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$	263	W

Diode-inverter

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_F	Diode Continuous Forward Current	35	A
I_{FM}	Diode Maximum Forward Current $t_p=1\text{ms}$	70	A

Diode-rectifier

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1600	V
I_O	Average Output Current 50Hz/60Hz,sine wave	35	A
I_{FSM}	Surge Forward Current $V_R=0\text{V}, t_p=10\text{ms}, T_j=45^{\circ}\text{C}$	600	A
I^2t	I^2t -value, $V_R=0\text{V}, t_p=10\text{ms}, T_j=45^{\circ}\text{C}$	1800	A^2s

IGBT-brake

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$	50	A
	@ $T_C=100^{\circ}\text{C}$	25	
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	50	A
P_D	Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$	202	W

Diode-brake

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_F	Diode Continuous Forward Current	15	A
I_{FM}	Diode Maximum Forward Current $t_p=1\text{ms}$	30	A

Module

Symbol	Description	Values	Unit
T_{jmax}	Maximum Junction Temperature(inverter,brake)	175	$^{\circ}\text{C}$
	Maximum Junction Temperature (rectifier)	150	
T_{jop}	Operating Junction Temperature	-40 to +150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}, t=1\text{min}$	2500	V

IGBT-inverter Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=35\text{A}, V_{GE}=15\text{V}, T_j=25^{\circ}\text{C}$		1.70	2.15	V
		$I_C=35\text{A}, V_{GE}=15\text{V}, T_j=125^{\circ}\text{C}$		1.95		
		$I_C=35\text{A}, V_{GE}=15\text{V}, T_j=150^{\circ}\text{C}$		2.00		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=0.88\text{mA}, V_{CE}=V_{GE}, T_j=25^{\circ}\text{C}$	5.2	6.0	6.8	V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$			1.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^{\circ}\text{C}$			100	nA
R_{Gint}	Internal Gate Resistance			0		Ω
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=35\text{A}, R_G=13\Omega, V_{GE}=\pm 15\text{V}, T_j=25^{\circ}\text{C}$		157		ns
t_r	Rise Time			30		ns
$t_{d(off)}$	Turn-Off Delay Time			210		ns
t_f	Fall Time			320		ns
E_{on}	Turn-On Switching Loss			2.05		mJ
E_{off}	Turn-Off Switching Loss			2.50		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=35\text{A}, R_G=13\Omega, V_{GE}=\pm 15\text{V}, T_j=125^{\circ}\text{C}$		158		ns
t_r	Rise Time			33		ns
$t_{d(off)}$	Turn-Off Delay Time			225		ns
t_f	Fall Time			505		ns
E_{on}	Turn-On Switching Loss			2.50		mJ
E_{off}	Turn-Off Switching Loss			3.80		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=35\text{A}, R_G=13\Omega, V_{GE}=\pm 15\text{V}, T_j=150^{\circ}\text{C}$		160		ns
t_r	Rise Time			35		ns
$t_{d(off)}$	Turn-Off Delay Time			230		ns
t_f	Fall Time			520		ns
E_{on}	Turn-On Switching Loss			2.65		mJ
E_{off}	Turn-Off Switching Loss			4.00		mJ
I_{SC}	SC Data	$t_p \leq 10\mu\text{s}, V_{GE}=15\text{V}, T_j=150^{\circ}\text{C}, V_{CC}=900\text{V}, V_{CEM} \leq 1200\text{V}$		140		A

Diode-inverter Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=35\text{A}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$		2.00	2.45	V
		$I_F=35\text{A}, V_{GE}=0\text{V}, T_j=125^{\circ}\text{C}$		1.90		
		$I_F=35\text{A}, V_{GE}=0\text{V}, T_j=150^{\circ}\text{C}$		1.88		
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=35\text{A},$ $R_G=13\Omega, V_{GE}=-15\text{V}$ $T_j=25^{\circ}\text{C}$		1.9		μC
I_{RM}	Peak Reverse Recovery Current			43		A
E_{rec}	Reverse Recovery Energy			1.01		mJ
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=35\text{A},$ $R_G=13\Omega, V_{GE}=-15\text{V}$ $T_j=125^{\circ}\text{C}$		3.1		μC
I_{RM}	Peak Reverse Recovery Current			51		A
E_{rec}	Reverse Recovery Energy			2.37		mJ
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=35\text{A},$ $R_G=13\Omega, V_{GE}=-15\text{V}$ $T_j=150^{\circ}\text{C}$		3.5		μC
I_{RM}	Peak Reverse Recovery Current			53		A
E_{rec}	Reverse Recovery Energy			2.77		mJ

Diode-rectifier Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=35\text{A}, V_{GE}=0\text{V}, T_j=150^{\circ}\text{C}$		1.02		V
I_R	Reverse Current	$T_j=150^{\circ}\text{C}, V_R=1600\text{V}$			3.0	mA

IGBT-brake Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=25\text{A}, V_{GE}=15\text{V}, T_j=25^{\circ}\text{C}$		1.70	2.15	V
		$I_C=25\text{A}, V_{GE}=15\text{V}, T_j=125^{\circ}\text{C}$		1.95		
		$I_C=25\text{A}, V_{GE}=15\text{V}, T_j=150^{\circ}\text{C}$		2.00		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=0.63\text{mA}, V_{CE}=V_{GE}, T_j=25^{\circ}\text{C}$	5.2	6.0	6.8	V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$			1.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^{\circ}\text{C}$			400	nA
R_{Gint}	Internal Gate Resistance			0		Ω
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=25\text{A}, R_G=18\Omega, V_{GE}=\pm 15\text{V}, T_j=25^{\circ}\text{C}$		148		ns
t_r	Rise Time			27		ns
$t_{d(off)}$	Turn-Off Delay Time			200		ns
t_f	Fall Time			338		ns
E_{on}	Turn-On Switching Loss			1.66		mJ
E_{off}	Turn-Off Switching Loss			1.64		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=25\text{A}, R_G=18\Omega, V_{GE}=\pm 15\text{V}, T_j=125^{\circ}\text{C}$		144		ns
t_r	Rise Time			27		ns
$t_{d(off)}$	Turn-Off Delay Time			217		ns
t_f	Fall Time			401		ns
E_{on}	Turn-On Switching Loss			1.92		mJ
E_{off}	Turn-Off Switching Loss			2.36		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=25\text{A}, R_G=18\Omega, V_{GE}=\pm 15\text{V}, T_j=150^{\circ}\text{C}$		142		ns
t_r	Rise Time			29		ns
$t_{d(off)}$	Turn-Off Delay Time			219		ns
t_f	Fall Time			523		ns
E_{on}	Turn-On Switching Loss			2.23		mJ
E_{off}	Turn-Off Switching Loss			2.69		mJ
I_{SC}	SC Data	$t_p \leq 10\mu\text{s}, V_{GE}=15\text{V}, T_j=150^{\circ}\text{C}, V_{CC}=900\text{V}, V_{CEM} \leq 1200\text{V}$		100		A

Diode-brake Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=15\text{A}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$		2.05	2.50	V
		$I_F=15\text{A}, V_{GE}=0\text{V}, T_j=125^{\circ}\text{C}$		2.20		
		$I_F=15\text{A}, V_{GE}=0\text{V}, T_j=150^{\circ}\text{C}$		2.25		
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=15\text{A},$ $R_G=39\Omega, V_{GE}=-15\text{V}$ $T_j=25^{\circ}\text{C}$		0.7		μC
I_{RM}	Peak Reverse Recovery Current			11		A
E_{rec}	Reverse Recovery Energy			0.54		mJ
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=15\text{A},$ $R_G=39\Omega, V_{GE}=-15\text{V}$ $T_j=125^{\circ}\text{C}$		2.4		μC
I_{RM}	Peak Reverse Recovery Current			13		A
E_{rec}	Reverse Recovery Energy			1.00		mJ
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=15\text{A},$ $R_G=39\Omega, V_{GE}=-15\text{V}$ $T_j=150^{\circ}\text{C}$		2.6		μC
I_{RM}	Peak Reverse Recovery Current			13		A
E_{rec}	Reverse Recovery Energy			1.12		mJ

NTC Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
R_{25}	Rated Resistance			5.0		k Ω
$\Delta R/R$	Deviation of R_{100}	$T_C=100^{\circ}\text{C}, R_{100}=493.3\Omega$	-5		5	%
P_{25}	Power Dissipation				20.0	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$		3375		K
$B_{25/80}$	B-value	$R_2=R_{25}\exp[B_{25/80}(1/T_2-1/(298.15\text{K}))]$		3411		K
$B_{25/100}$	B-value	$R_2=R_{25}\exp[B_{25/100}(1/T_2-1/(298.15\text{K}))]$		3433		K

Module Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
L_{CE}	Stray Inductance		35		nH
$R_{CC'+EE'}$ $R_{AA'+CC'}$	Module Lead Resistance, Terminal to Chip		4.00 3.00		m Ω
R_{thJC}	Junction-to-Case (per IGBT-inverter) Junction-to-Case (per Diode-inverter) Junction-to-Case (per Diode-rectifier) Junction-to-Case (per IGBT-brake) Junction-to-Case (per Diode-brake)			0.569 1.068 0.995 0.742 1.760	K/W
R_{thCH}	Case-to-Sink (per IGBT-inverter) Case-to-Sink (per Diode-inverter) Case-to-Sink (per Diode-rectifier) Case-to-Sink (per IGBT-brake) Case-to-Sink (per Diode-brake) Case-to-Sink (per per Module)		0.274 0.515 0.480 0.358 0.849 0.020		K/W
M	Mounting Torque, Screw:M5	3.0		6.0	N.m
G	Weight of Module		200		g

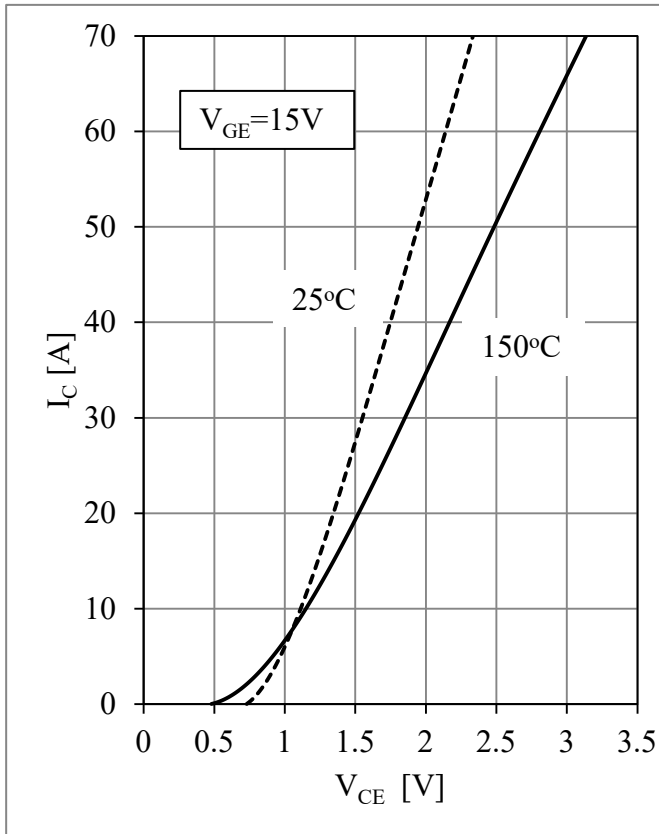


Fig 1. IGBT-inverter Output Characteristics

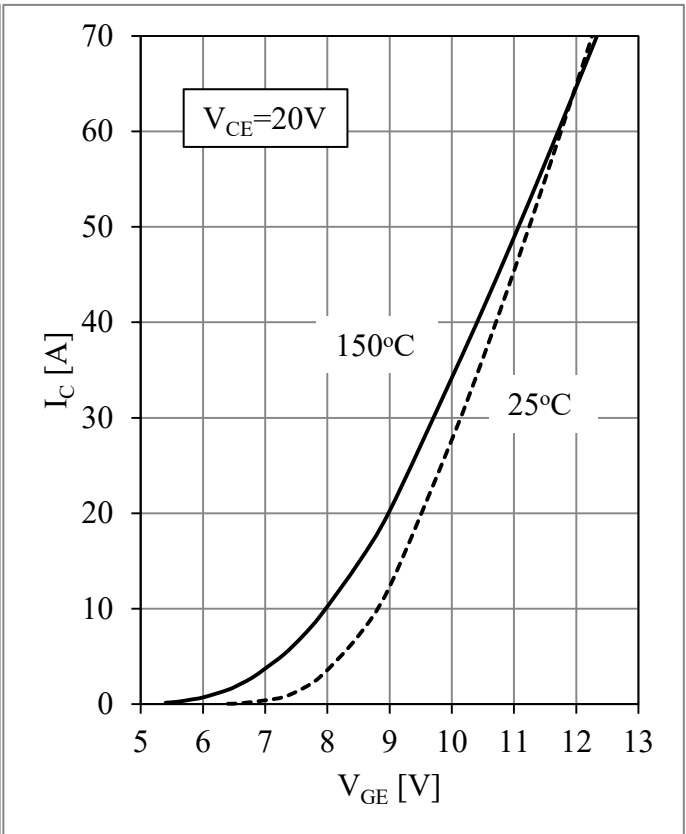
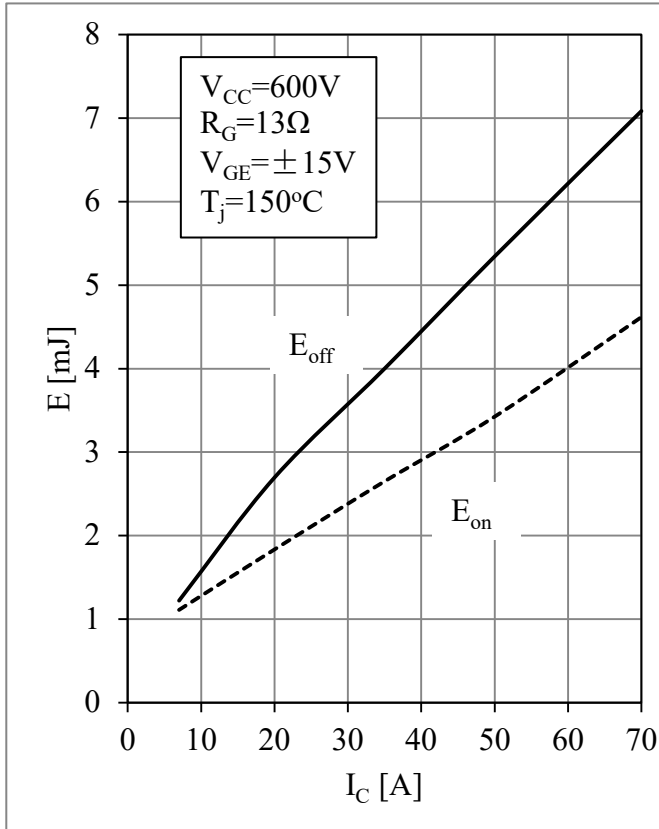
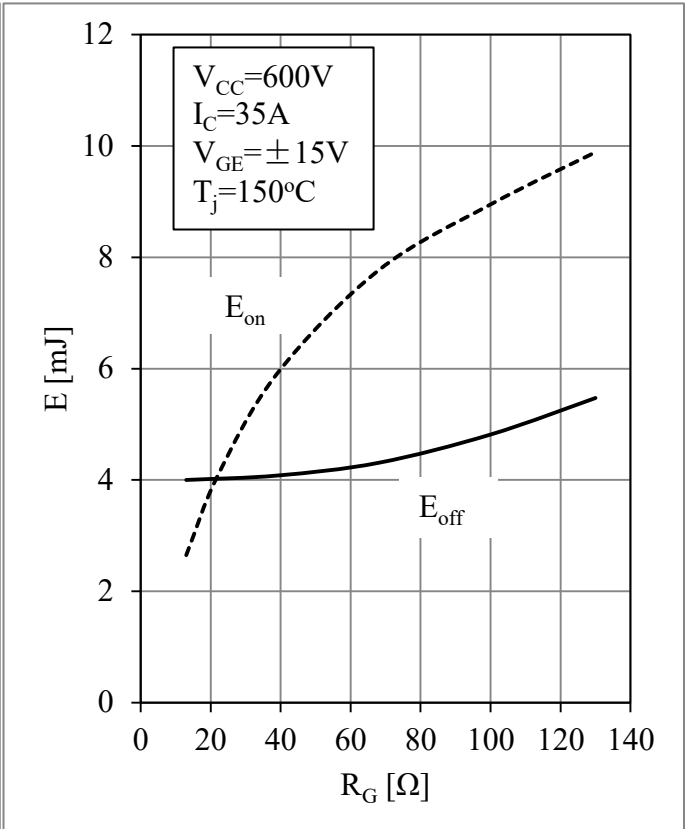


Fig 2. IGBT-inverter Transfer Characteristics

Fig 3. IGBT-inverter Switching Loss vs. I_C Fig 4. IGBT-inverter Switching Loss vs. R_G

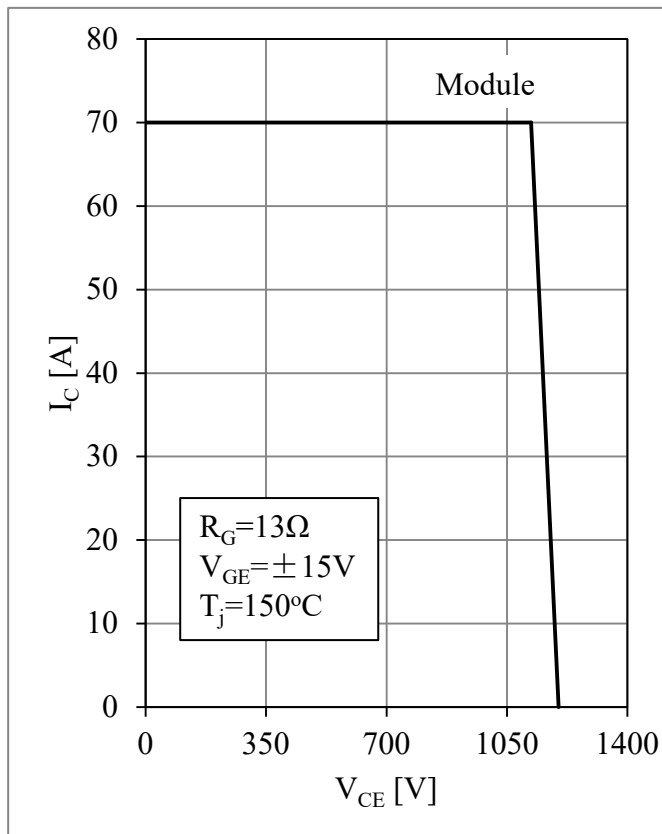


Fig 5. IGBT-inverter RBSOA

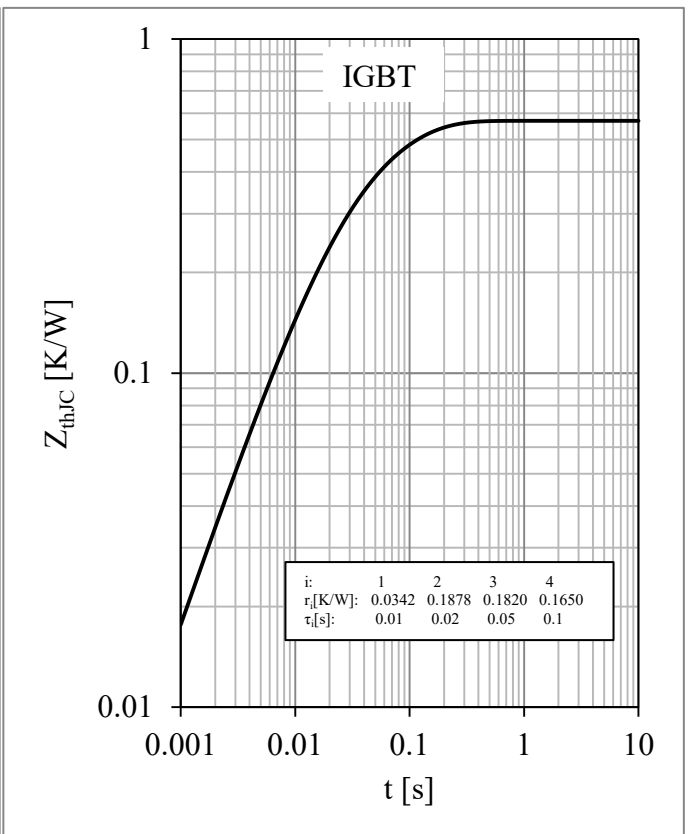


Fig 6. IGBT-inverter Transient Thermal Impedance

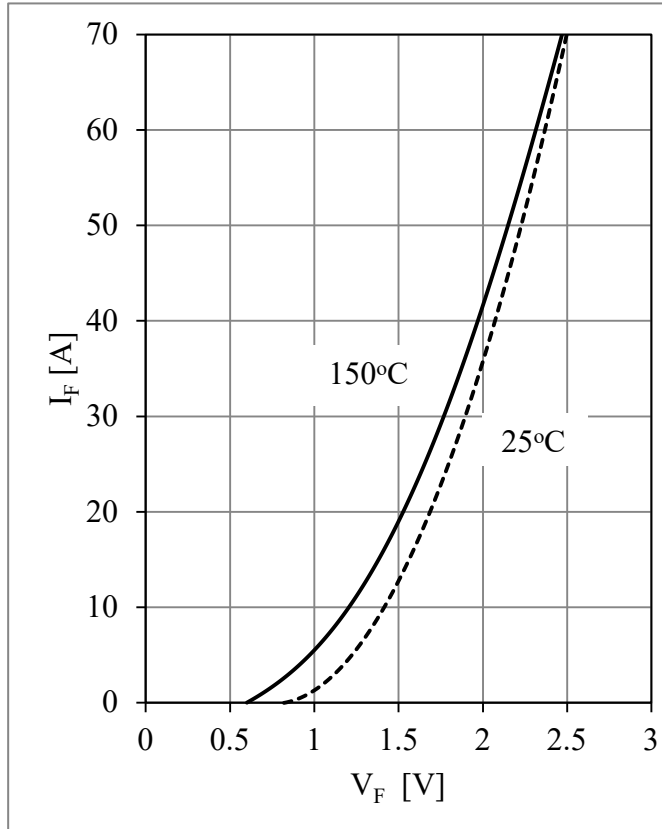
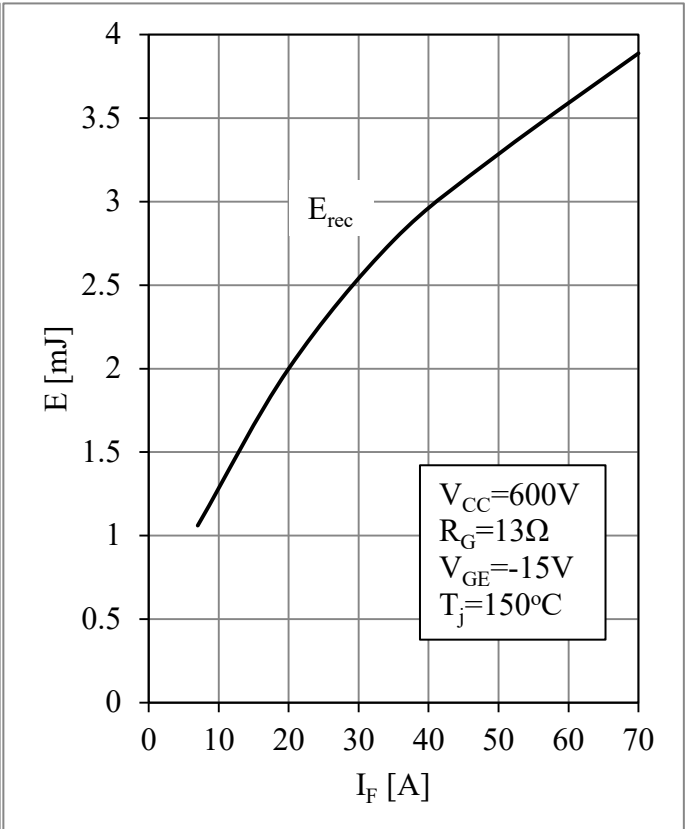


Fig 7. Diode-inverter Forward Characteristics

Fig 8. Diode-inverter Switching Loss vs. I_F

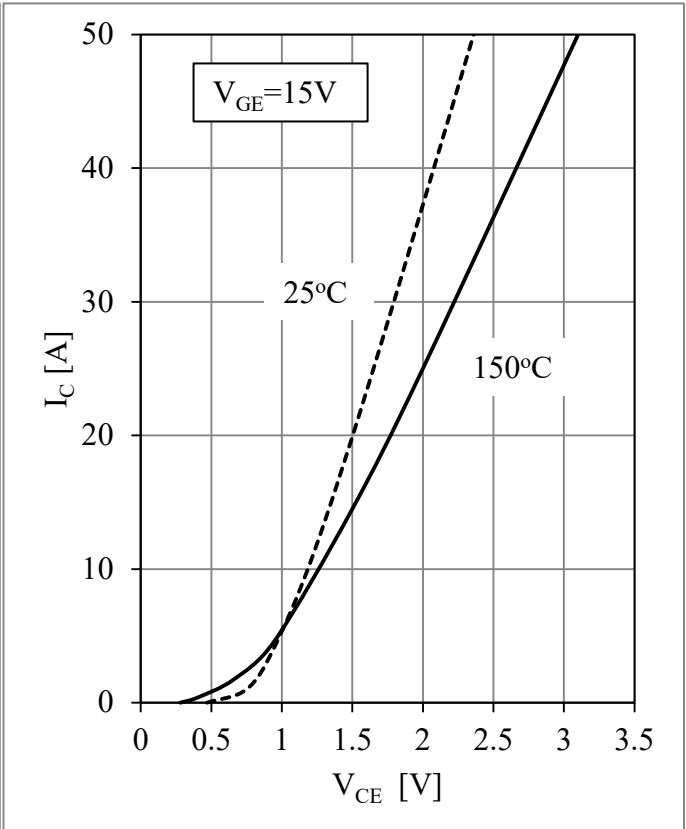
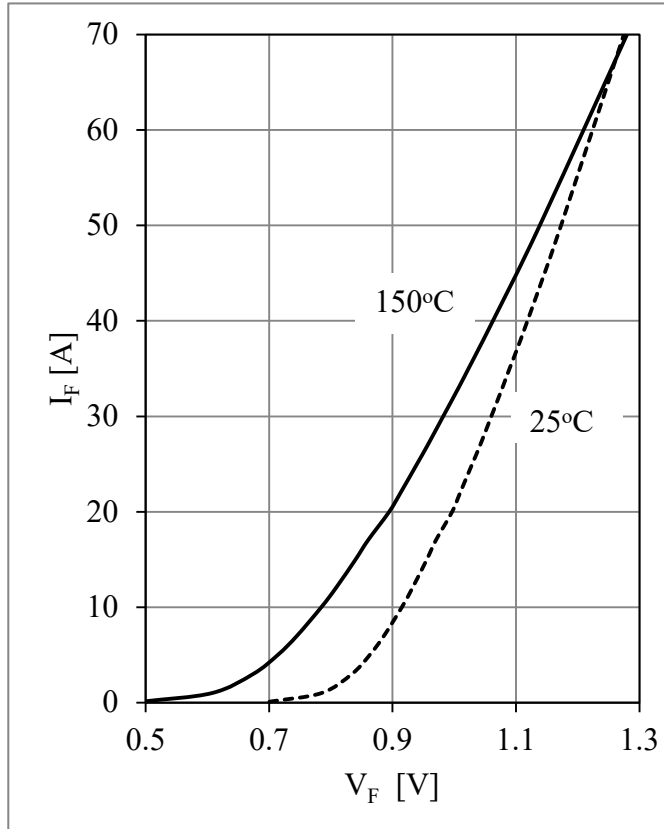
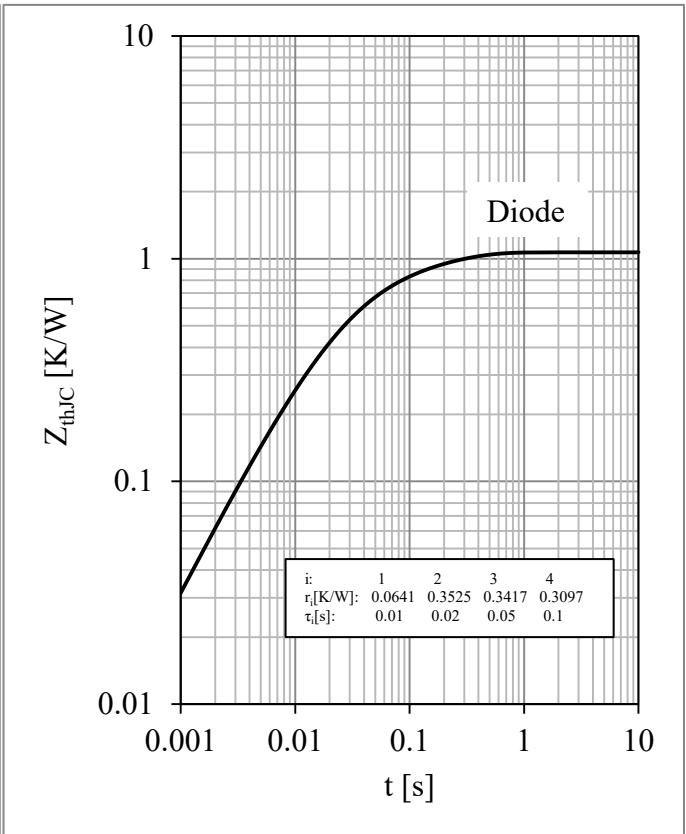
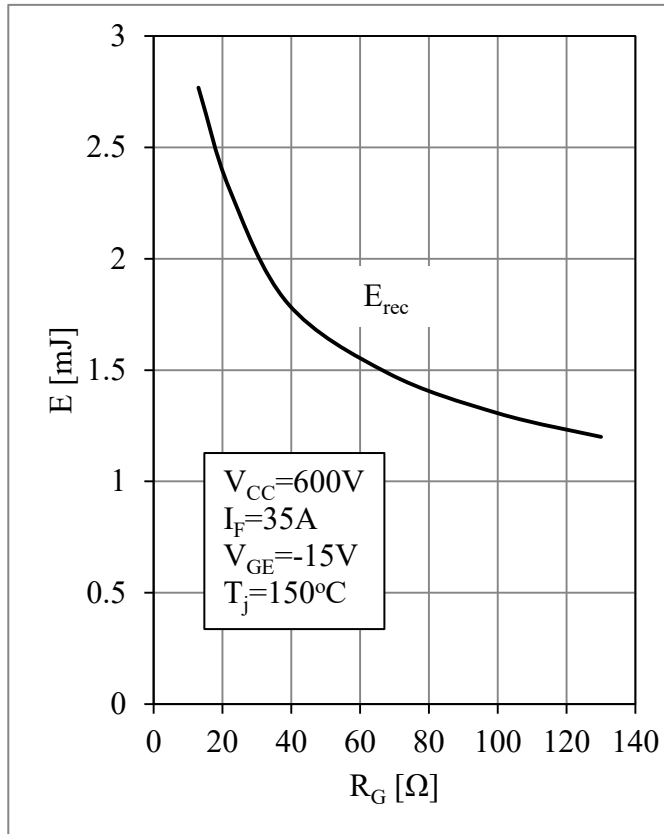


Fig 11. Diode-rectifier Forward Characteristics

Fig 12. IGBT-brake-chopper Output Characteristics

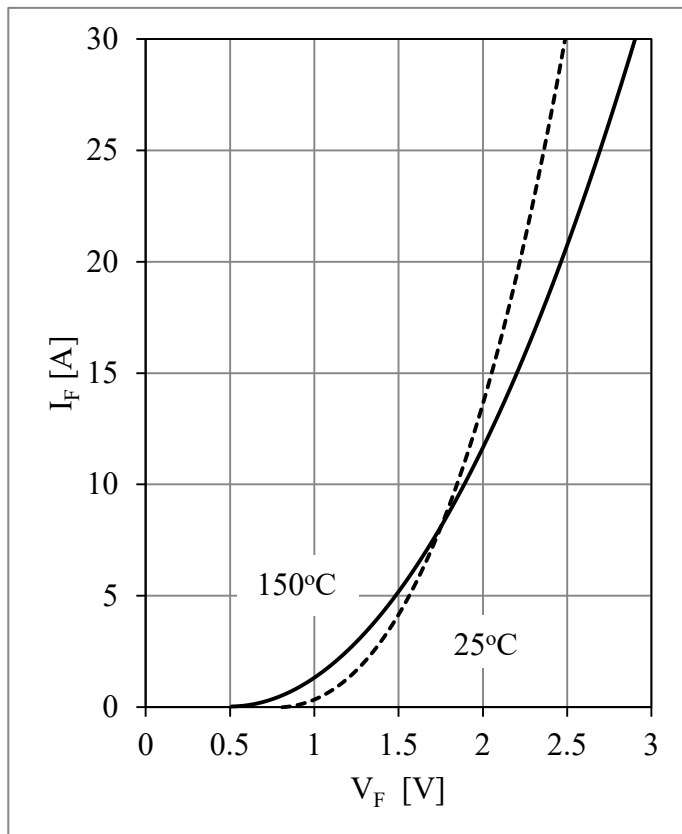


Fig 13. Diode-brake-chopper Forward Characteristics

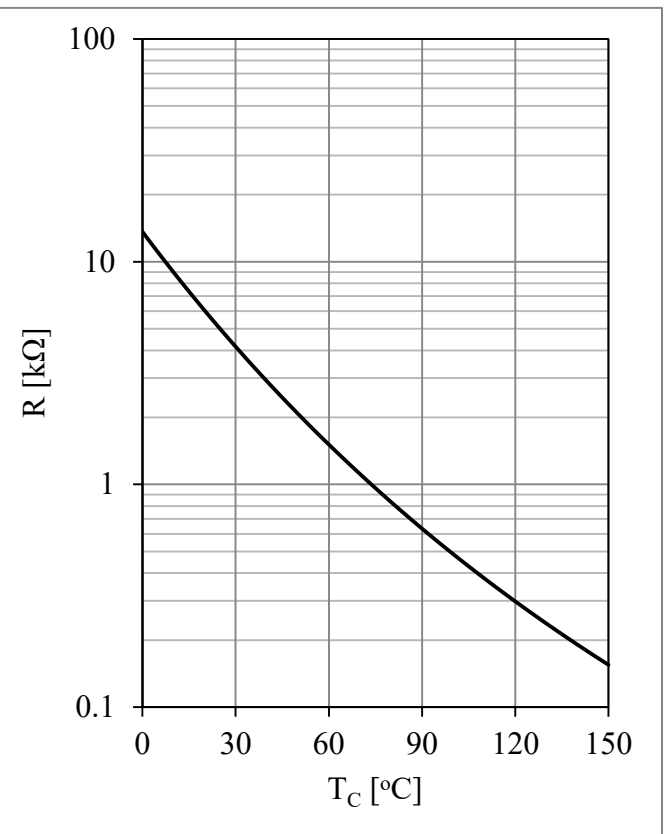
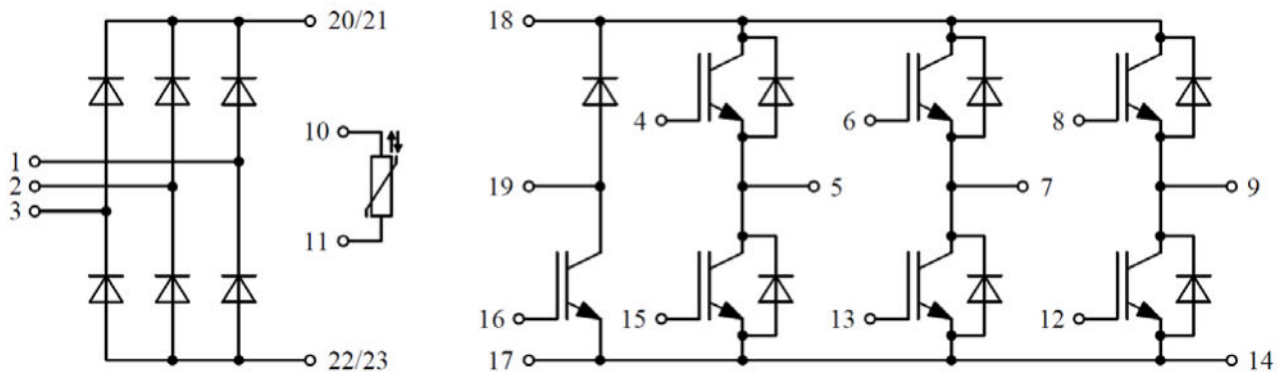


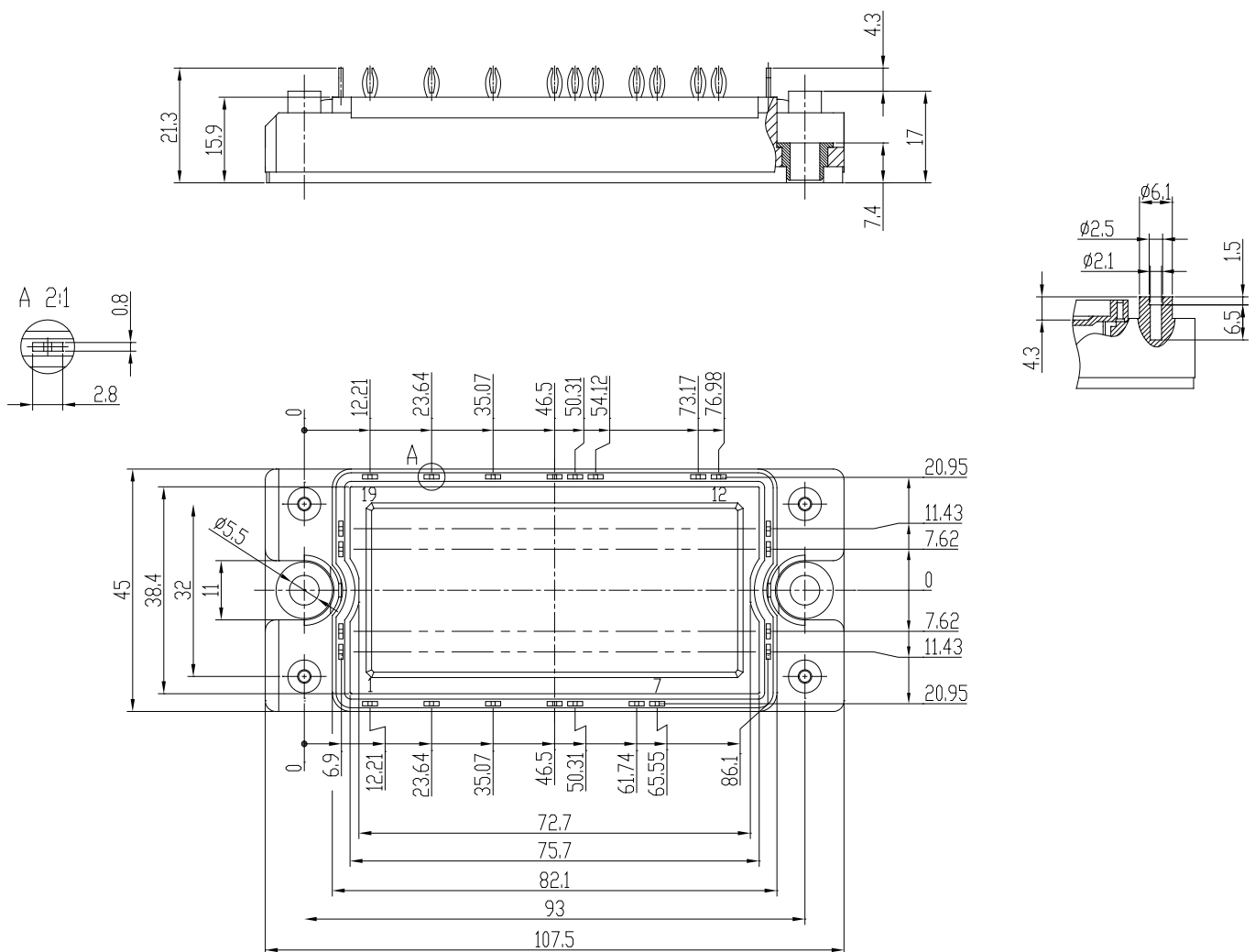
Fig 14. NTC Temperature Characteristic

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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